# 27–31 GHz GaAs MMIC Driver Amplifier



AA028P2-00

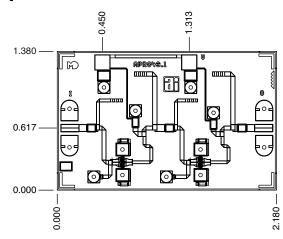
#### **Features**

- Single Bias Supply Operation (6 V)
- 14 dB Typical Small Signal Gain
- 16 dBm Typical P<sub>1 dB</sub> Output Power at 28 GHz
- 0.25 µm Ti/Pd/Au Gates
- 100% On-Wafer RF and DC Testing
- 100% Visual Inspection to MIL-STD-883 MT 2010

#### **Description**

Alpha's two-stage reactively-matched 27–31 GHz GaAs MMIC driver amplifier has typical small signal gain of 14 dB with a typical  $P_{1\ dB}$  of 16 dBm at 28 GHz. The chip uses Alpha's proven 0.25  $\mu m$  MESFET technology, and is based upon MBE layers and electron beam lithography for the highest uniformity and repeatability. The FETs employ surface passivation to ensure a rugged, reliable part with through-substrate via holes and gold-based backside metallization to facilitate a conductive epoxy die attach process. All chips are screened for gain, output power and S-parameters prior to shipment for guaranteed performance. Designed for 27–31 GHz LMDS and digital radio bands.

## **Chip Outline**



Dimensions indicated in mm. All DC (V) pads are  $0.1 \times 0.1 \text{ mm}$  and RF In, Out pads are 0.07 mm wide. Chip thickness = 0.1 mm.

## **Absolute Maximum Ratings**

| Characteristic                          | Value             |  |
|---|-------------------|--|
| Operating Temperature (T <sub>C</sub> ) | -55°C to +90°C    |  |
| Storage Temperature (T <sub>ST</sub> )  | -65°C to +150°C   |  |
| Bias Voltage (V <sub>D</sub> )          | 7 V <sub>DC</sub> |  |
| Power In (P <sub>IN</sub> )             | 16 dBm            |  |
| Junction Temperature (T <sub>J</sub> )  | 175°C             |  |

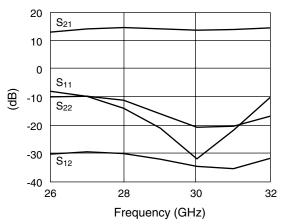
# Electrical Specifications at $25^{\circ}$ C ( $V_{DS} = 6$ V)

| Parameter                             | Condition     | Symbol            | Min. | Typ. <sup>2</sup> | Max. | Unit |
|---------------------------------------|---------------|-------------------|------|-------------------|------|------|
| Drain Current                         |               | I <sub>DS</sub>   |      | 80                | 110  | mA   |
| Small Signal Gain                     | F = 27–31 GHz | G                 | 12   | 14                |      | dB   |
| Input Return Loss                     | F = 27–31 GHz | RL                |      | -11               | -6   | dB   |
| Output Return Loss                    | F = 27–31 GHz | RLO               |      | -12               | -6   | dB   |
| Output Power at 1 dB Gain Compression | F = 28 GHz    | P <sub>1 dB</sub> | 13   | 16                |      | dBm  |
| Saturated Output Power                | F = 28 GHz    | P <sub>SAT</sub>  | 14   | 17                |      | dBm  |
| Thermal Resistance <sup>1</sup>       |               | Θ <sub>JC</sub>   |      | 198               |      | °C/W |

Calculated value based on measurement of discrete FET.

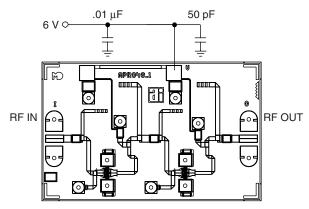
Typical represents the median parameter value across the specified frequency range for the median chip.

# **Typical Performance Data**



Typical Small Signal Performance S-Parameters (V<sub>DS</sub> = 6 V)

#### **Bias Arrangement**



For biasing on, adjust  $V_{DS}$  from zero to the desired value (6 V recommended). For biasing off, reverse the biasing on procedure.

#### **Circuit Schematic**

